

Surface mount transient voltage suppressor power 400 watts

Stand-Off Voltage : 5.0V~440V

FEATURES

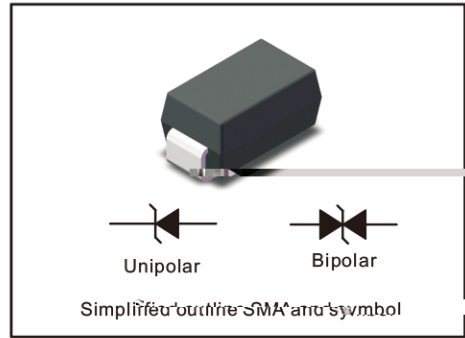
- For surface mounted applications in order to optimize board space.
- Low profile package
- Glass passivated junction
- Low inductance
- Plastic package has Underwriters Laboratory Flammability

MECHANICAL DATA

- Case: SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.055g/0.002oz

PINNING

PIN	DESCRIPTION
1	Cathode
2	Anode



Maximum Ratings and Electrical characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Peak Pulse Power Dissipation at T _A = 25 °C (Note 4, Fig 4)	P _{PPM}	400	W
Peak Forward Surge Current (Note 3, Fig 4)	I _{FSM} (UNI)	60	A
Peak Pulse Current on 10/1000 us waveform (Note 1, Fig 3)	I _{PPM1000}	See Table 1	A
ESD Voltage per IEC6100-4-2	Contact	V _{ESD1}	±30
	Air	V _{ESD2}	±30
Typical Thermal Resistance Junction to Ambient (Note 2)	R _{θJA}	86	°C/W
Operating Junction Temperature and Storage Temperature Range	T _J , T _{stg}	-65 ~ +150	°C

NOTES:

1. Non-repetitive unless otherwise specified. All ratings are based on 25 °C ambient temperature.
2. Mounted on 5mm² copper pads to each terminal.
3. Peak Forward Surge Current: 0.5ms single half sine-wave superimposed on rated load (JEDEC method).
4. Peak pulse power waveform is 10/1000us.

Fig.1 Peak Pulse Power Rating Curve

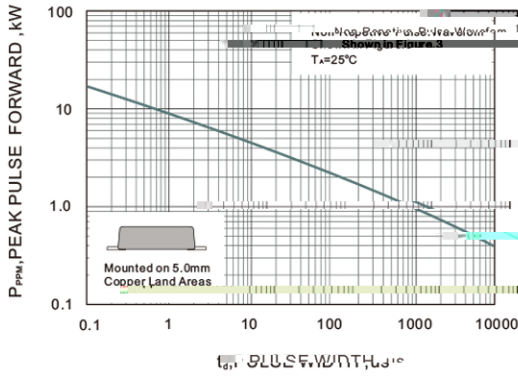


Fig.2 Forward Current Derating Curve

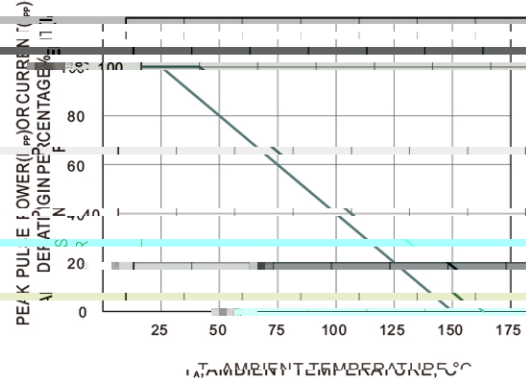


Fig.3 Pulse Waveform

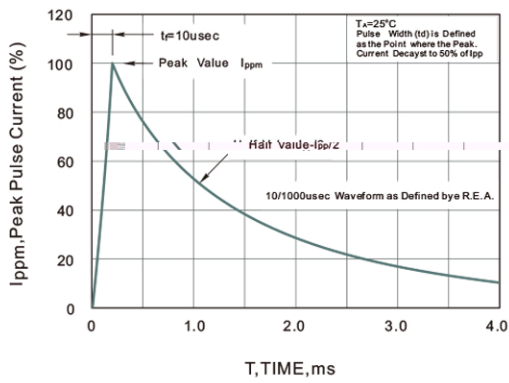
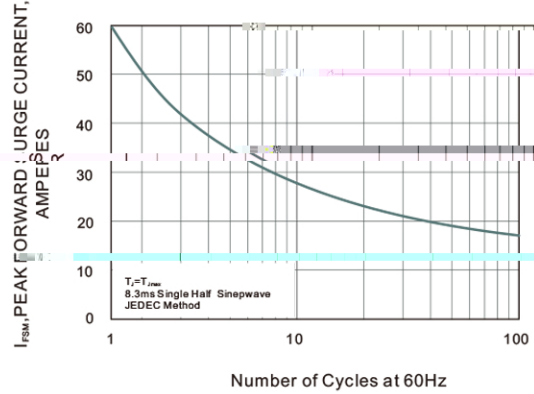


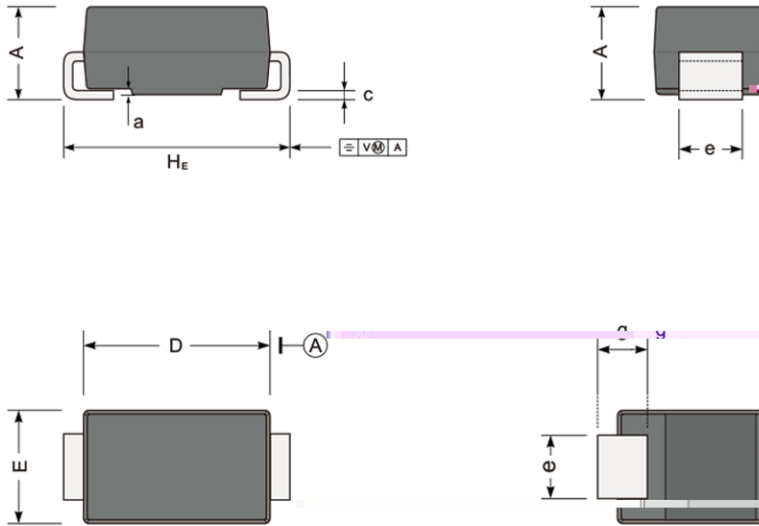
Fig.4 Maximum Non-Repetitive Peak Forward Surge Current



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads

SMA



UNIT		A	D	E	H _E	c	e	g	a
mm	max	2.2	4.5	2.7	5.2	0.31	1.6	1.5	0.3
	min	1.9	4.0	2.3	4.7	0.15	1.3	0.9	
mil	max	87	181	106	205	12	63	59	12
	min	75	157	91	185	6	51	35	

The recommended mounting pad size

